



Product Change Notification - RMES-23CSSZ273

Date:

24 Feb 2020

Product Category:

Ethernet PHYs

Affected CPNs:**Notification subject:**

CCB 3437 Final Notice: Qualification of GTK as a new assembly site for selected Micrel KSZ9021xx device family available in 64L LQFP (10x10x1.4mm) package.

Notification text:**PCN Status:**

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:

Qualification of GTK as a new assembly site for selected Micrel KSZ9021xx device family available in 64L LQFP (10x10x1.4mm) package.

Pre Change:

Assembled at TICIP using CEL-9200 mold compound material

Post Change:

Assembled at GTK using G700H mold compound

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	Taiwan IC Packing Corp (TICP)	GREATEK ELECTRONIC INC. (GTK)
Wire material	Au	Au
Die attach material	EN4900	EN4900
Molding compound material	CEL-9200	G700H
Lead frame material	C7025	C7025

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve on-time delivery performance by qualifying GTK as a new assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:



March 24, 2020 (date code: 2013)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

Workweek	June 2019					->	February 2020					March 2020				
	22	23	24	25	26		05	06	07	08	09	10	11	12	13	14
Initial PCN Issue Date					X											
Qual Report Availability											X					
Final PCN Issue Date											X					
Estimated Implementation Date															X	

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

June 26, 2019: Issued initial notification.

February 24, 2020: Issued final notification. Attached the qualification report. Revised the notification subject/description of change to state the device family affected.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

[PCN_RMES-23CSSZ273_Qual_Report.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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